

UNISONIC TECHNOLOGIES CO., LTD

8NM50

Preliminary

8.0A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

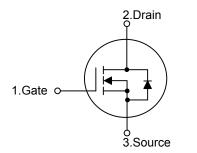
DESCRIPTION

The **UTC 8NM50** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)}$ < 0.49 Ω @ V_{GS} =10V, I_{D} =4.0A
- * High Switching Speed
- * 100% Avalanche Tested

SYMBOL



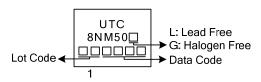
ORDERING INFORMATION

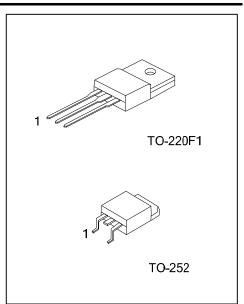
Ordering Number		Pin Assignment			Deaking	
Halogen Free	гаскауе	1	2	3	Packing	
8NM50G-TF1-T	TO-220F1	G	D	S	Tube	
8NM50G-TN3-R	TO-252	G	D	S	Tape Reel	
	Halogen Free 8NM50G-TF1-T	Halogen Free Package 8NM50G-TF1-T TO-220F1	Halogen FreePackage118NM50G-TF1-TTO-220F1G	Halogen Free Package 1 2 8NM50G-TF1-T TO-220F1 G D	Halogen FreePackage1238NM50G-TF1-TTO-220F1GDS	

Note: Pin Assignment: G: Gate D: Drain S: Source

8NM50L-TF1-T (1)Packing Type	(1) T: Tube, R: Tape Reel	
(2)Package Type	(2) TF1: TO-220F1, TN3: TO-252	
(3)Green Package	(3) L: Lead Free, G: Halogen Free and Lead Free	

MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	500	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	I _D	8.0	А
	Pulsed (Note 2)	I _{DM}	32	А
Avalanche Current (Note 2)		I _{AR}	3.3	А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	54	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	8.0	V/ns
Power Dissipation	TO-220F1		42	W
	TO-252	PD	80	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 10mH, I_{AS} = 3.3A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C

4. $I_{SD} \le 8.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1	0	62.5	°C/W
	TO-252	θ_{JA}	110	°C/W
Junction to Case	TO-220F1	0	3	°C/W
	TO-252	θ _{JC}	1.56	°C/W



■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise noted)

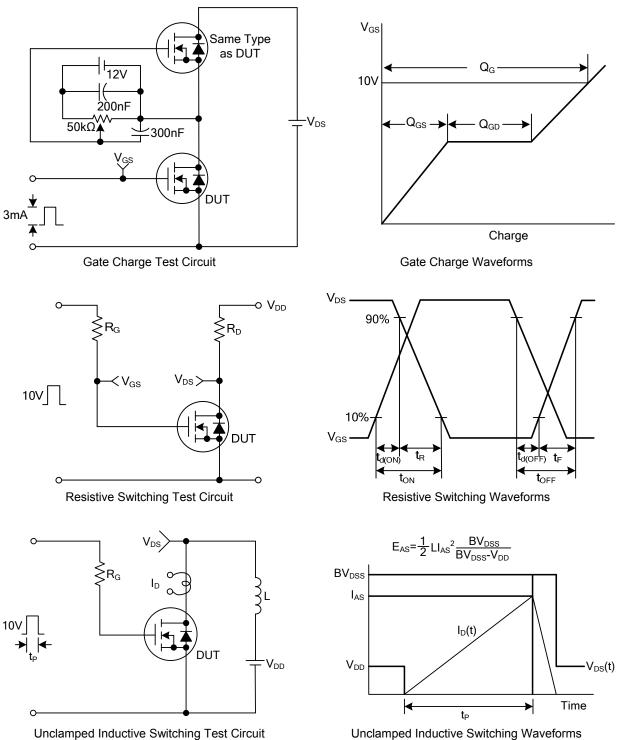
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TVD	MAY	
PARAMETER SYMBOL TEST CONDITIONS MIN TYP MAX UNIT OFF CHARACTERISTICS						UNIT	
		BV _{DSS}	I _D =250µA, V _{GS} =0V	500			V
Drain-Source Breakdown Voltage			V_{DS} =500V, V_{GS} =0V	500		1	v uA
Drain-Source Leakage Current Forward Gate- Source Leakage Current		I _{DSS}					- F
		- I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V
Static Drain-Source On-State Res	istance	R _{DS(ON)}	V _{GS} =10V, I _D =4.0A			0.49	Ω
DYNAMIC PARAMETERS							-
Input Capacitance		CISS			460		pF
Output Capacitance Reverse Transfer Capacitance		C _{OSS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		430		рF
		C _{RSS}			62		рF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, I _D =1.3A, I _G =100µA		30		nC
Gate to Source Charge Gate to Drain Charge		Q_{GS}	V_{GS} =10V (Note 1,2)		3		nC
		Q_{GD}			13		nC
Turn-ON Delay Time (Note 1)		t _{D(ON)}			50		ns
Rise Time Turn-OFF Delay Time Fall-Time		t _R	V_{DD} =30V, I_{D} =0.5A, R_{G} =25 Ω ,		104		ns
		t _{D(OFF)}	V _{GS} =10V (Note 1,2)		182		ns
		t _F			93		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous	Current	Is				8.0	Α
Maximum Body-Diode Pulsed Cur	rent	I _{SM}				32	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =8.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Tir	ne (Note 1)	t _{rr}	I _S =8.0A, V _{GS} =0V,		270		ns
Body Diode Reverse Recovery Charge		Qrr	dI _F /dt=100A/µs		3.05		μC

Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%

2. Essentially independent of operating temperature



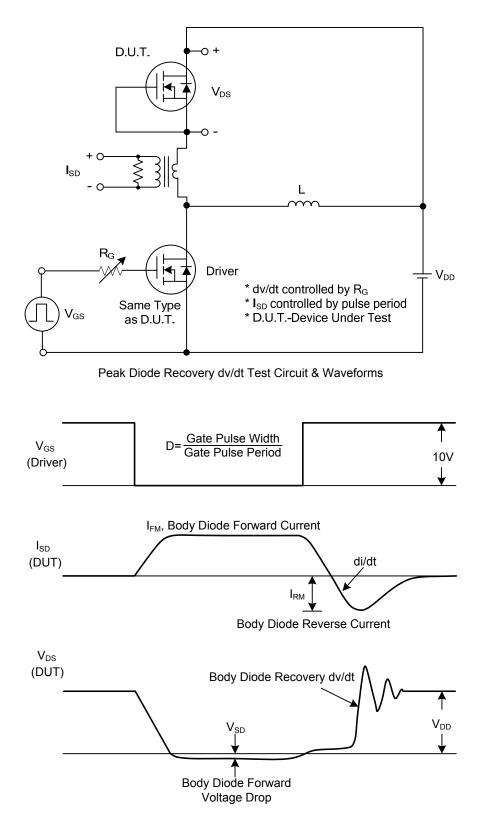
TEST CIRCUITS AND WAVEFORMS



Unclamped Inductive Switching Waveforms



■ TEST CIRCUITS AND WAVEFORMS(Cont.)



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